BUSSMANN SERIES

EREC3006TC

Hyperfast rectifier



Photo is representative

- Plastic package UL 94V-0
- Low reverse leakage current
- Hyperfast recovery time and soft recovery characteristics
- Low recovery loss

Product features

Applications

- Switched mode power supplies (SMPS)
- Inverters
- Freewheeling diodes
- DC/DC converters
- Other power switching applications

Environmental compliance and general specifications





Mechanical data

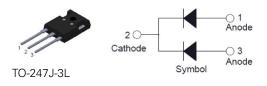
• Case: TO-247J molded plastic over passivated junction

Terminals: Tin platedWeight: 6.0 gram typical

Ordering part number

Ε	R	Ε	С	30	06	TC	
1	2	3	4	5	6	7	

Package diagram/size and schematic



1	E=Eaton
2	R=Rectifier
3	E=Epitaxial process
4	C=Hyperfast
5	30=I _F (AV): 30 A
6	06=V _{BBM} : 600 V
7	TC=Package: TO-247J-3L
	common cathode



Absolute maximum ratings

(Rating at +25 °C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	V
Maximum RMS voltage	V_{RMS}	420	V
Maximum DC blocking voltage	V _{DC}	600	V
Average forward current at $T_c = 140 ^{\circ}\text{C}$	I _{F(AV)}	30	А
Peak forward surge current: 10 ms single half sinewave superimposed on rated load	I _{FSM}	150	А
Operating junction and storage temperature range	T _j , T _{stg}	-55 to +150	°C

Electrical characteristics

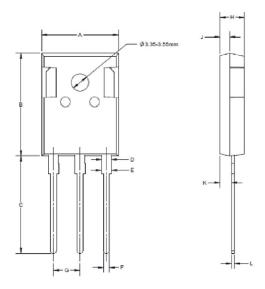
(Rating at +25 °C ambient temperature unless otherwise specified)

Parameter	Test condition	Symbol	Minimum	Typical	Maximum	Unit
Farward valtage @IF 1F A	Tj=25 °C		-	2.7	3.2	V
Forward voltage @IF=15 A	Tj=150 °C	− V _F		1.4	2	
Reverse current at rated DC	Tj=25 °C	1	-	-	5	
blocking voltage	Tj=150 °C	— I _R	-	-	300	μΑ
	IF=1 A, VR=30 V, di/dt=200 A/μs, Tj=25 °C	– t _{rr}	-	13	18	ns
Reverse recovery time	IF=15 A, VR=200 V, di/dt=200 A/ μs, Tj=25 °C		-	28	-	
	IF=15 A, VR=200 V, di/dt=200 A/ μs, Tj=125 °C		-	39	-	
Peak reverse recovery current	IF=15 A, VR=200 V, di/dt=200 A/ μs, Tj=25 °C		-	2.1	-	Δ
	IF=15 A, VR=200 V, di/dt=200 A/ μs,Tj=125 °C	— I _{RM}	-	5.8	-	— А
Reverse recovery charge	IF=15 A, VR=200 V, di/dt=200 A/ μs, Tj=25 °C	0	-	30	-	-0
	IF=15 A, VR=200 V, di/dt=200 A/ μs, Tj=125 °C	- U _m	-	115	-	nC

Thermal resistances

Symbol	Parameter	Minimum	Typical	Maximum	Unit
R _{th(c-h)}	Thermal resistance from case to heatsink	-	0.25	-	°C /W
R _{th(j-mb)}	Thermal resistance from junction to mounting base	-	-	1.6	°C /W

Mechanical drawing- mm



Dimension	Minimum	Typical	Maximum
A	15.50	15.80	16.10
В	20.80	21	21.20
С	19.70	20	20.30
D	1.80	2	2.20
E	1.90	2.10	2.30
F	1	1.20	1.40
G	-	5.44	-
Н	4.80	5	5.20
J	1.90	2	2.10
K	2.20	2.35	2.50
L	0.41	0.60	0.79

Marking



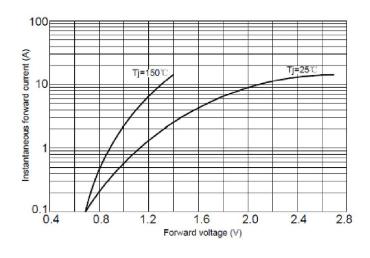
Product information			
С	Hyperfast		
30	I _{F(AV)} : 30 A		
06	V _{RRM} : 600 V		
TC	Package: TO-247J-3L common cathode		
F35	Date code		

Packaging information

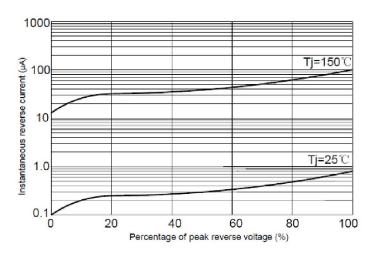
Outline	Unit weight	Tube	Per carton
	(g/pcs) typical	(pcs)	(pcs)
TUBE	6.0	30	1800

Typical characteristics

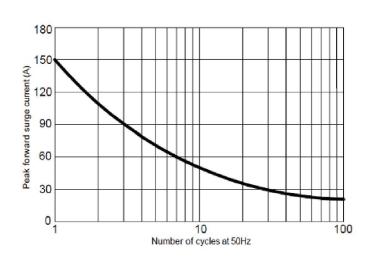
Typical forward characteristics



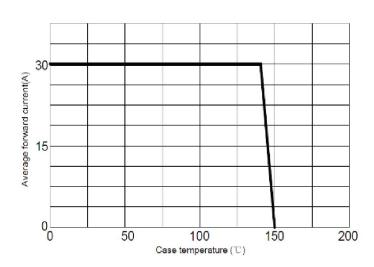
Typical reverse characteristics



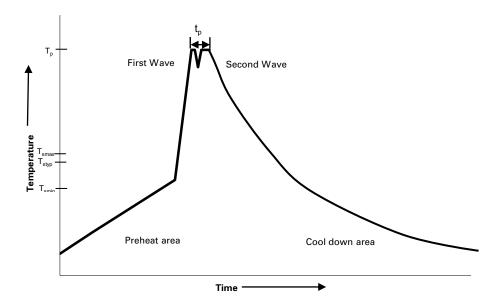
Maximum non-repetitive peak forward surge current (10 ms single half sine-wave) (+25 $^{\circ}\text{C})$



Forward current derating curve



Wave solder profile



Reference EN 61760-1:2006

Profile feature		Standard SnPb solder	Lead (Pb) free solder	
Preheat	• Temperature min. (T _{Smin})	100 °C	100 °C	
	• Temperature typ. (T _{Styp})	120 °C	120 °C	
	• Temperature max. (T _{smax})	130 °C	130 °C	
	• Time (T _{smin} to T _{smax}) (t _s)	70 seconds	70 seconds	
Δ preheat to max Temperature		150 °C max.	150 °C max.	
Peak temperature (T _P)*		235 °C − 260 °C	250 °C – 260 °C	
Time at peak temperature (t _p)		10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave	
Ramp-down	rate	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	
Time 25 °C to 25 °C		4 minutes	4 minutes	

Manual solder

Use a 20 watt soldering iron with tip diameter of 1.0 mm maximum. +350 °C, 4-5 seconds maximum, generally manual, hand soldering is not recommended

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